

Supplier Name: Texas Instruments Inc. (DUNS# 00-732-1904)
 Contact Info: ti.com/support
 Form/Declaration Type: Distribute - RoHS and IEC 62474 DB
 Created on: 06/03/2022

Details for "LP592201D5CT"

Current Product Information

TI part number	Lead finish/Ball material	MSL rating/peak reflow	Assembly site	Package Pins	Package body size (mm)	Total device mass (mg)*
LP592201D5CT	NIPDAU	Level-1-260C-UNLIM	TI Semiconductor	DSC 10	3x3x0.7	26

*Total Device Mass

The summary mass is a rounded value and will be within approximately +/- 10% of the detailed mass value.

Environmental Ratings Information

RoHS	REACH	Green	IEC 62474 DB
Yes	Yes	Yes	Yes

Component Information

Component	Substance	CAS Number	Amount (mg)	Homogeneous Material Level		Component Level	
				Percentage %	ppm	Percentage %	ppm
Bond Wire							
Copper and Its Alloys	Copper	7440-50-8	0.244327	99.997954	999980	0.938173	9382
Copper and Its Alloys	Iron	7439-89-6	0.000001	0.000409	4	0.000004	0
Other Nonferrous Metals and Alloys	Manganese	7439-96-5	0.000001	0.000409	4	0.000004	0
Precious Metals	Silver	7440-22-4	0.000003	0.001228	12	0.000012	0
Sub-Total			0.244332	100	1000000	0.938193	9382
Die Attach Adhesive							
Precious Metals	Silver	7440-22-4	0.347066	80.000092	800001	1.332673	13327
Thermoplastics	Epoxy	85954-11-6	0.086766	19.999908	199999	0.333166	3332
Sub-Total			0.433832	100	1000000	1.66584	16658
Lead Frame							
Copper and Its Alloys	Copper	7440-50-8	15.6032	97.52	975200	59.913584	599136
Copper and Its Alloys	Iron	7439-89-6	0.368	2.3	23000	1.413056	14131
Copper and Its Alloys	Phosphorus	7723-14-0	0.0048	0.03	300	0.018431	184
Zinc and Its Alloys	Zinc	7440-66-6	0.024	0.15	1500	0.092156	922
Sub-Total			16	100	1000000	61.437227	614372
Lead Frame Plating							
Nickel and Its Alloys	Nickel	7440-02-0	0.4756	95.12	951200	1.826222	18262
Precious Metals	Gold	7440-57-5	0.0039	0.78	7800	0.014975	150
Precious Metals	Palladium	7440-05-3	0.0205	4.1	41000	0.078716	787
Sub-Total			0.5	100	1000000	1.919913	19199
Mold Compound							
Other Inorganic Materials	Fused Silica	60676-86-0	6.956227	88.000005	880000	26.710706	267107
Other Organic Materials	Chlorine	7782-50-5	0.000079	0.000999	10	0.000303	3
Other Plastics and Rubber	Carbon Black	1333-86-4	0.023714	0.299995	3000	0.091058	911
Thermoplastics	Epoxy	85954-11-6	0.924783	11.699001	116990	3.551006	35510
Sub-Total			7.904803	100	1000000	30.353074	303531
Semiconductor Device							
Ceramics / Glass	Doped Silicon	7440-21-3	0.959875	100	1000000	3.685754	36858
Sub-Total			0.959875	100	1000000	3.685754	36858
Total			26.042842			100	1000000

Important Note

The ppm calculations are at the **homogeneous material** level and are maximum concentration values. The ppm displayed represents the **homogeneous material** with the highest ppm for that substance. The amount (mg) calculations represent the maximum total amount of each substance within the component.
 The ppm calculations are at the **component** level and are average concentration values. The amount (mg) calculations represent the average total amount of each substance within the **component**.
[See Glossary of Terms for more details.](#)

Important Part Information

There is a remote possibility the Customer Part Number (CPN) your company uses could reference more than one TI part number. This is due to two or more users (EMSI or subcontractors) using the same CPN for different TI part numbers. If this occurs, please check your Customer Part Number and cross reference it with the TI part number seen on this page.

Product Content Methodology

[For an explanation of the methods used to determine material weights, See Product Content Methodology.](#)

Material Declaration Certificate for Semiconductor IC Packaged Products

TI certifies that the material content information provided by TI is representative and accurate to the best of their knowledge based on material information provided by its suppliers and their combination into finished IC packaged products. TI semiconductor products designated to be "Pb-free", "Green" or "RoHS Exempt" fully meets the latest EU RoHS Directive requirements along with other legislation as seen in the former JIG-101 list that has been transferred to the IEC 62474 database.

Important Information/Disclaimer

TI bases its material content information on information provided by third-party suppliers and has taken, and continues to take, reasonably diligent steps to provide any required or available information. TI may not have conducted destructive testing or chemical analysis on incoming materials and chemicals. TI and TI suppliers may consider certain information to be proprietary, and thus certain information may not be available for release by TI. The material content information is provided by TI "as is."

[For additional information, please contact TI customer support.](#)

Signature: [\(click here for a fuller statement with a signed certificate\)](#)

Name/Title: Hubie Payne, Vice President, Worldwide SC Quality
 For further environmental statements, please go to www.ti.com/ecoinfo
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RoHS: Means TI semiconductor products that are compliant with the current RoHS requirement that the maximum concentration values of the ten substances listed in RoHS Annex II do not exceed 0.1 % by weight in homogeneous materials. **Where designed to be soldered at high temperatures,** TI semiconductor products labeled as "RoHS Compliant" are suitable for use in specified lead-free processes. TI may also reference these types of semiconductor products as "Pb-Free." These TI semiconductor products are also fully compliant with GADSL and the IEC 62474 database for electronic requirements.

RoHS Exempt: Means TI semiconductor products that contain lead (Pb) above the RoHS Annex II threshold, but that fall within one of the specific RoHS exemptions noted above or documented in <http://www.ti.com/lit/pdf/szq088>

Green: Means the content of Chlorine (Cl) and Bromine (Br)-based flame retardants meet JS709B low halogen requirements of <=1 000ppm threshold; Antimony trioxide (Sb2O3) contained in halogen based flame retardant materials meets the <=1 000ppm threshold requirement; and Beryllium Oxide (BeO) is <=1000ppm.